

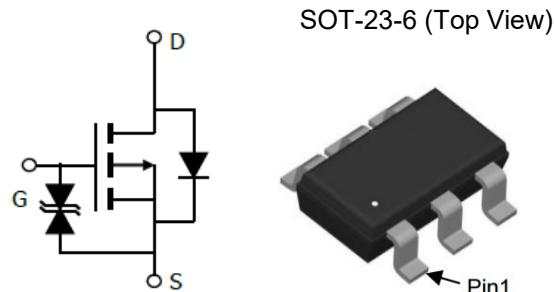
Description

CM2615E is the P-Channel enhancement mode power field effect transistors with high cell density, trench technology. This high density process and design have been optimized switching performance and especially tailored to minimize on-state resistance.

Features

- V_{DS}: -20V
- I_D: -4.7A
- R_{DS(on)} (@V_{GS}=-4.5V) : < 42mΩ
- R_{DS(on)} (@V_{GS}=-2.5V) : < 55mΩ
- R_{DS(on)} (@V_{GS}=-1.8V) : < 100mΩ
- High density cell design for extremely low R_{DS(on)}
- Excellent on-resistance and DC current capability

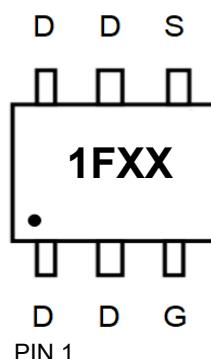
Equivalent Circuit and Pin Configuration



Applications

- Cellular Handsets and Accessories
- Personal Digital Assistants
- Portable Instrumentation
- Load switch

Marking Information



Marking Code = 1F
Date Code = XX

Ordering Information

Part Number	Packaging	Reel Size
CM2615E	3000/Tape & Reel	7 inch

Absolute Maximum Ratings (TA=25 °C unless otherwise noted)

Parameter	Symbol	Maximum	Unit
Drain-source Voltage	V _{DS}	-20	V
Gate-source Voltage	V _{GS}	±12	V
Continuous Drain Current	I _D	-4.7	A
		-3.8	A
Pulsed Drain Current ⁽¹⁾	I _{DM}	-23	A
Total Power Dissipation @ TA=25°C ⁽²⁾	P _D	1.4	W
Thermal Resistance Junction-to-Ambient ⁽²⁾	R _{θJA}	90	°C/W
Junction and Storage Temperature Range	T _{J,TSTG}	-55 to +150	°C

Electrical Characteristics (T_J=25 °C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V, I _D =-250μA	-20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _D =-20V, V _{GS} =0V, T _C =25°C		-1		μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±10V, V _D =0V			±10	μA
Gate Threshold Voltage	V _{GS(th)}	V _D =V _{GS} , I _D =-250μA	-0.4		-1.0	V
Static Drain-Source on-Resistance	R _D (on)	V _{GS} =-4.5V, I _D =-4.7A		29	42	mΩ
		V _{GS} =-2.5V, I _D =-4.3A		39	55	
		V _{GS} =-1.8V, I _D =-2.0A		63	100	
Diode Forward Voltage	V _{SD}	I _S =-4.7A, V _{GS} =0V		-0.8	-1.2	V
Maximum Body-Diode Continuous Current	I _S				-4.7	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _D =-10V, V _{GS} =0V, f=1MHz		1060		pF
Output Capacitance	C _{oss}			138		
Reverse Transfer Capacitance	C _{rss}			122		
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =-4.5V, V _D =-10V, I _D =-4A		7.3		nC
Gate Source Charge	Q _{gs}			1.1		
Gate Drain Charge	Q _{gd}			1.5		
Turn-on Delay Time	t _{D(on)}	V _{GS} =-4.5V, V _{DD} =-9V, R _L =2.5Ω, R _{GEN} =3Ω		14		ns
Turn-on Rise Time	t _r			63		
Turn-off Delay Time	t _{D(off)}			20		
Turn-off Fall Time	t _f			11		

Noted: (1) Pulse Test: Pulse Width≤300us,Duty cycle ≤2%.

(2) Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch. With 2oz Copper ,t≤10s

Typical Performance Characteristics

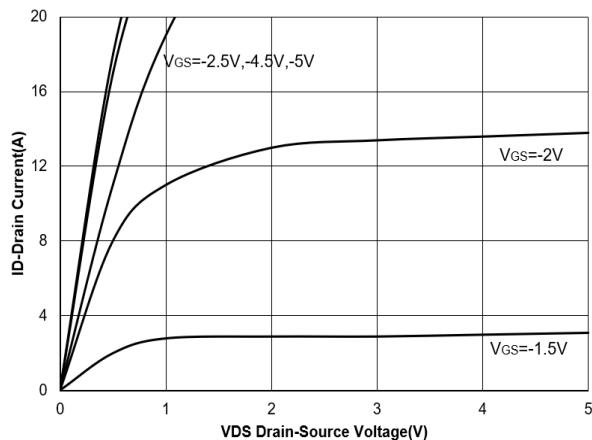


Figure 1. Output Characteristics

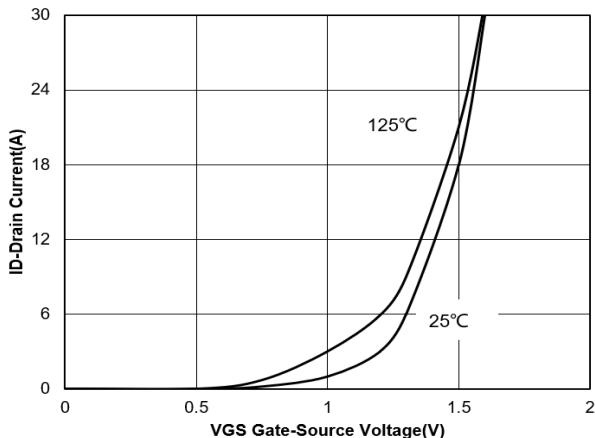


Figure 2. Transfer Characteristics

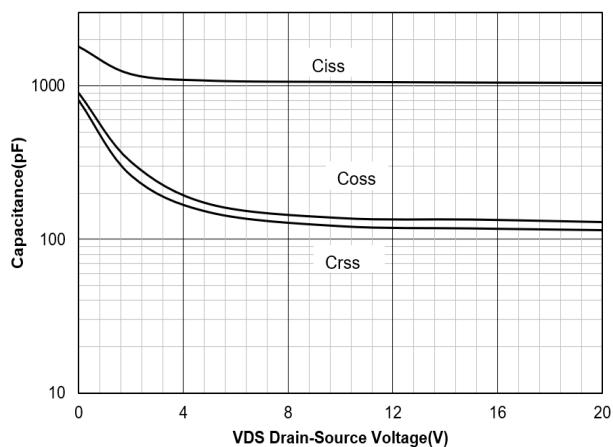


Figure 3. Capacitance Characteristics

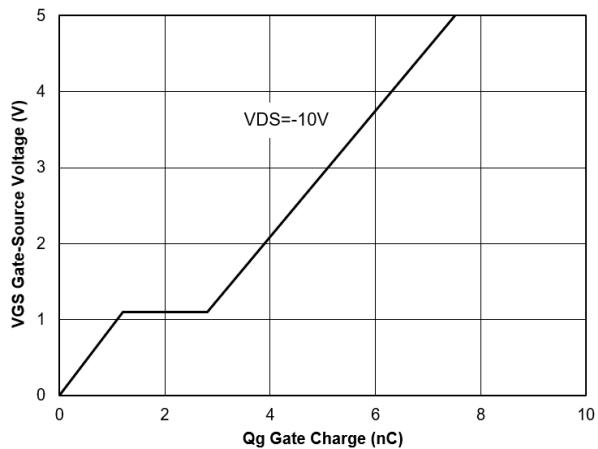


Figure 4. Gate Charge

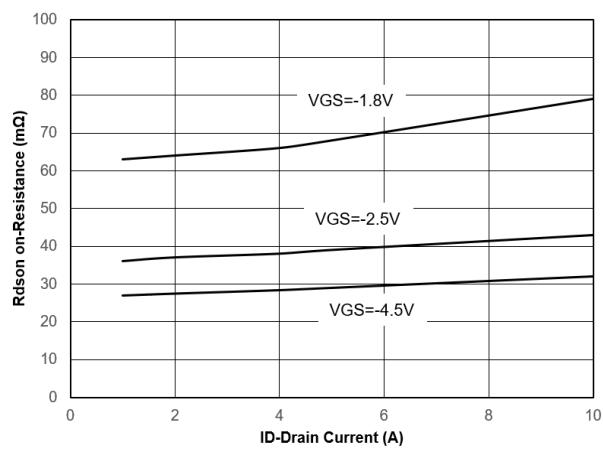


Figure 5. Drain-Source on Resistance

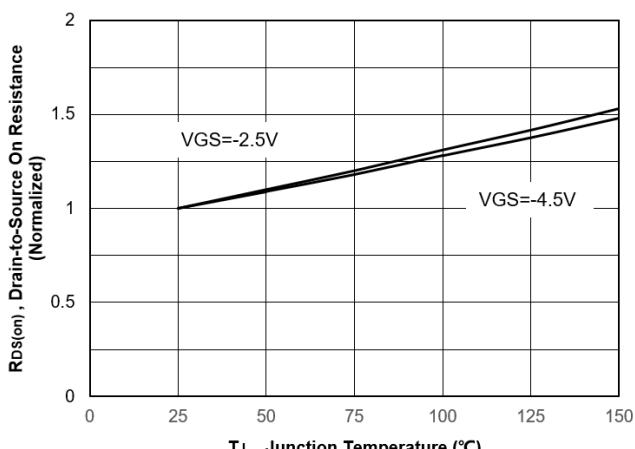


Figure 6. Normalized On-Resistance Vs. Temperature

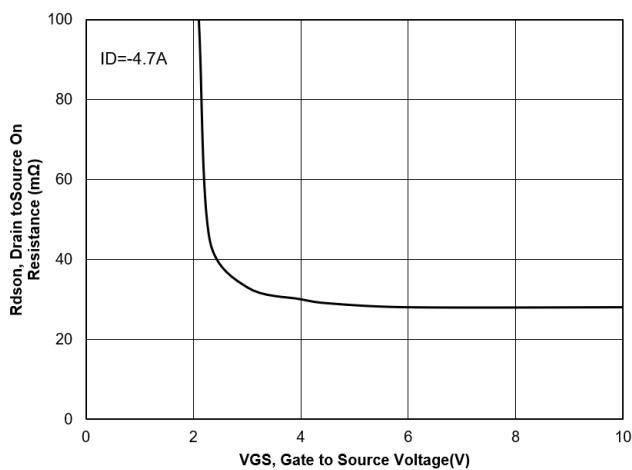


Figure 7. Typical Drain to Source ON Resistance
VS Gate Voltage and Drain Current

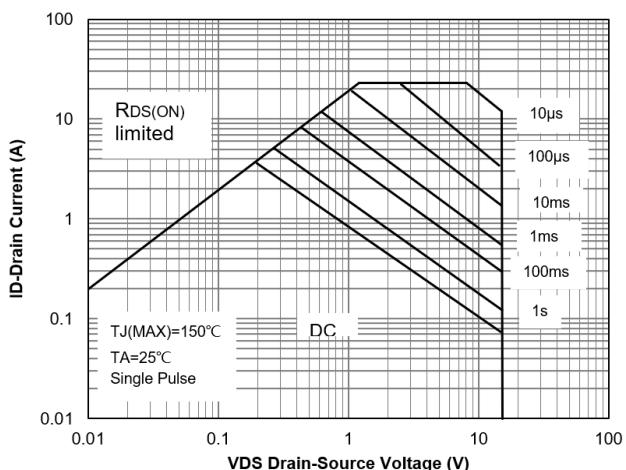


Figure 8. Safe Operation Area

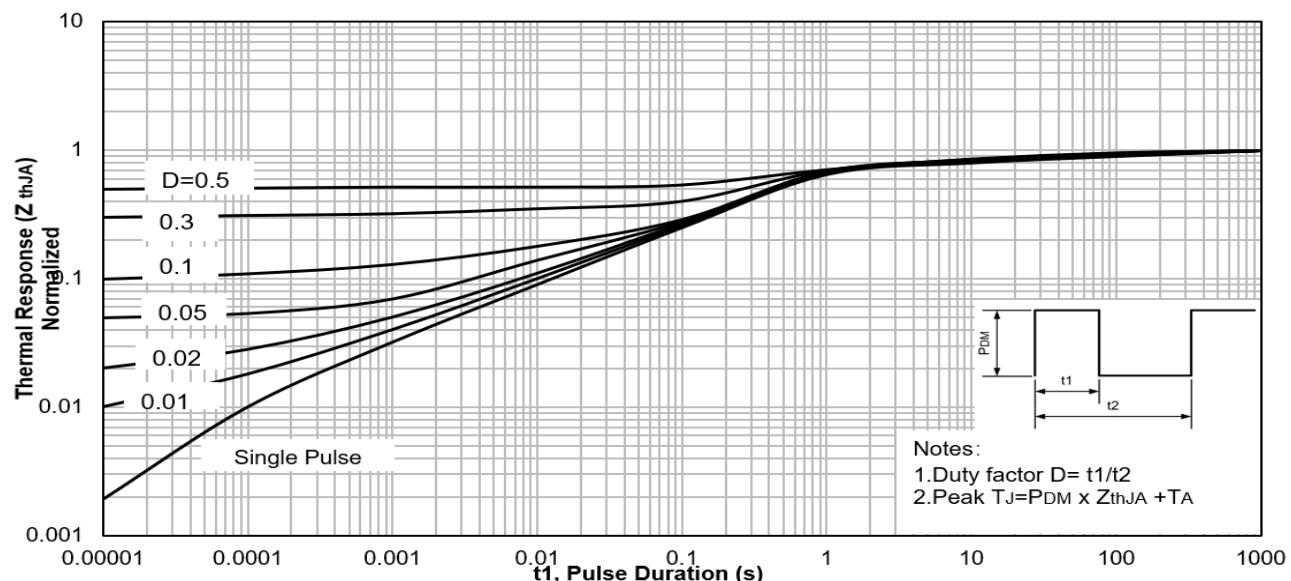


Figure 9. Maximum Effective Transient Thermal Impedance ,Junction-to-Ambient

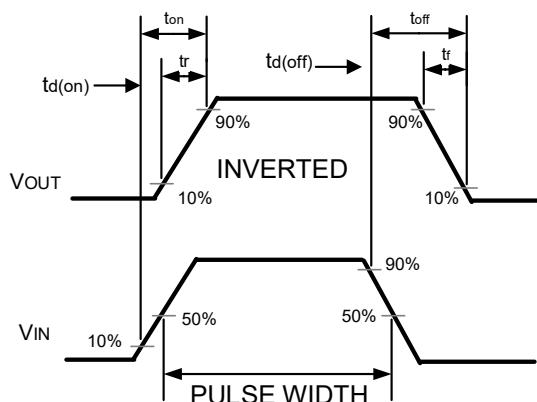
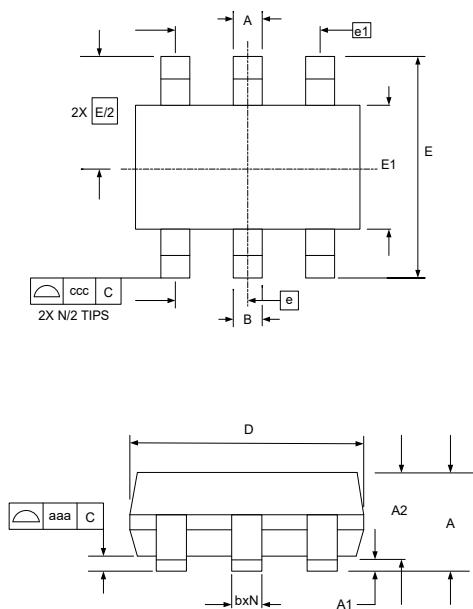


Figure 10. Switching wave

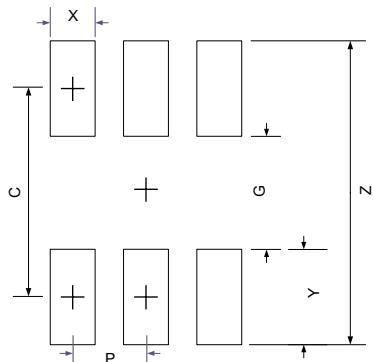
SOT-23-6 Package Outline Drawing

(Unit : mm)



SYM	DIMENSIONS					
	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.90		1.45	0.035		0.057
A1	0.00		0.15	0.000		0.006
A2	0.90	1.15	1.30	0.035	0.045	0.051
b	0.25		0.50	0.010		0.020
c	0.08		0.22	0.003		0.009
D	2.80	2.90	3.10	0.110	0.114	0.122
E1	1.50	1.60	1.75	0.060	0.063	0.069
E	2.80 BSC			0.110 BSC		
e	0.95 BSC			0.037 BSC		
e1	1.90 BSC			0.075 BSC		
N	6			6		
aaa	0.10			0.004		
ccc	0.20			0.008		

Suggested Land Pattern



SYM	DIMENSIONS	
	MILLIMETERS	INCHES
C	2.50	0.098
G	1.40	0.055
P	0.95	0.037
X	0.60	0.024
Y	1.10	0.043
Z	3.60	0.141

Contact Information

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